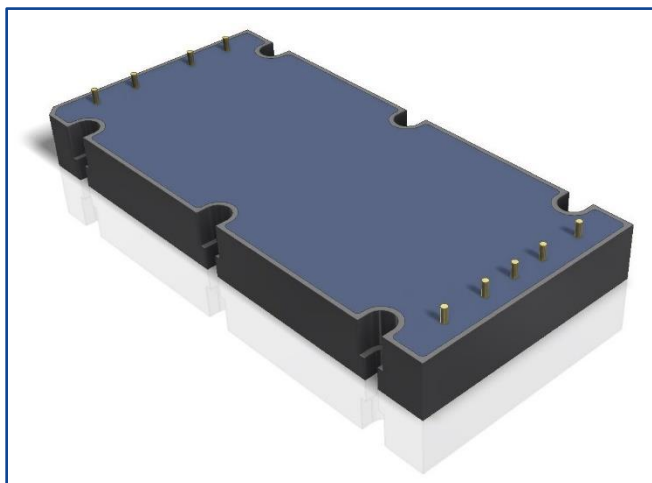


## Features

- Output power up to 500 W, 100 W/inch<sup>3</sup>
- Operating case temperature -55 ... +100 °C
- Efficiency up to 91 %
- Case dimensions:  
117x56x13 (mm)
- CNC milled case
- Input 180-375 VDC (300 VDC nom.)
- Service functions



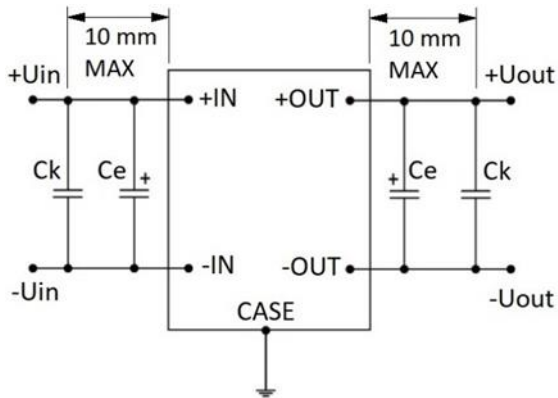
## Description

JETDiR series of DC/DC isolated converters meant for operation in harsh environmental conditions. A packet of electro-technical and mechanical parameters creates versatility for the series to be used in various application fields: both low and high altitude in unprotected equipment compartments, in all types of transport, in supercomputers, in low and high temperature environments, digital signage equipment, in radar systems. The series is an optimal fit for any environment which requires low-profile, minimized dimensions and weight, high efficiency and wide temperature range.

Base models (1 channel)					
Model part number	Input voltage	Output power	Output voltage	Output current per channel	Typical efficiency at 70 % load
JETDiR700-R(PinToPin-V300A24M500)	180-375 VDC (300 VDC nom.) 400 VDC 100ms transient	500 W	24 VDC	20.80 A	90 %
JETDiR700-R(PinToPin-V300A36M500)		500 W	36 VDC	13.90 A	91 %

General characteristics <sup>3</sup>		
Switching frequency		330 kHz typ. (PWM modulation)
Temperature ranges	case operating temperature	-55° C ... +100° C
	storage temperature	-60° C ... +125° C
Over-temperature protection		+105° C typ.
Thermal mode and cooling method	cooling methods, from most preferred (for the unit to be used with a coldplate or heatsink it's necessary to consult with the producer)	1. Conductive - heatsink-coldplate. 2. Forced air heatsink cooler. 3. Convectional heatsink cooling with vertical orientation of itself and vertical orientation of its ribs for free air flow from bottom to top.
Thermal resistance	case to ambient	-
Humidity (non-condensing)		5-95 % rel. H
Insulation	in/case	1500 VDC
	in/out	3000 VDC
	out/case	500 VDC
Isolating resistance @ 500 VDC		>20 MOhm
Thermal shock, mechanical shock & vibration		MIL-STD-810F
Safety standards		IEC/EN 60950-1
Typical MTBF	$P_{out} = 0.7 \cdot P_{out,max}$	110 000 hrs (T <sub>case</sub> = 50° C)
Weight (max)		270 g
Input characteristics <sup>3</sup>		
Input voltage range	"300"	180-375 VDC (300 VDC nom.) 400 VDC 100ms transient
	-	-
	-	-
Output characteristics <sup>3</sup>		
Power derating based on input voltage	-	no derating
Output voltage regulation	input variance U <sub>in,min</sub> to U <sub>in,max</sub>	±0.5 % for load 10-100 %
	load variance 10 % to 100 %	±2 %
Ripple and noise (peak-to-peak)	20 MHz bandwidth	<2 % for load 10-100 %
Protection	over-current	auto-reset at 110-150 % of I <sub>out,nom</sub>
	over-voltage	<130 % U <sub>out</sub>

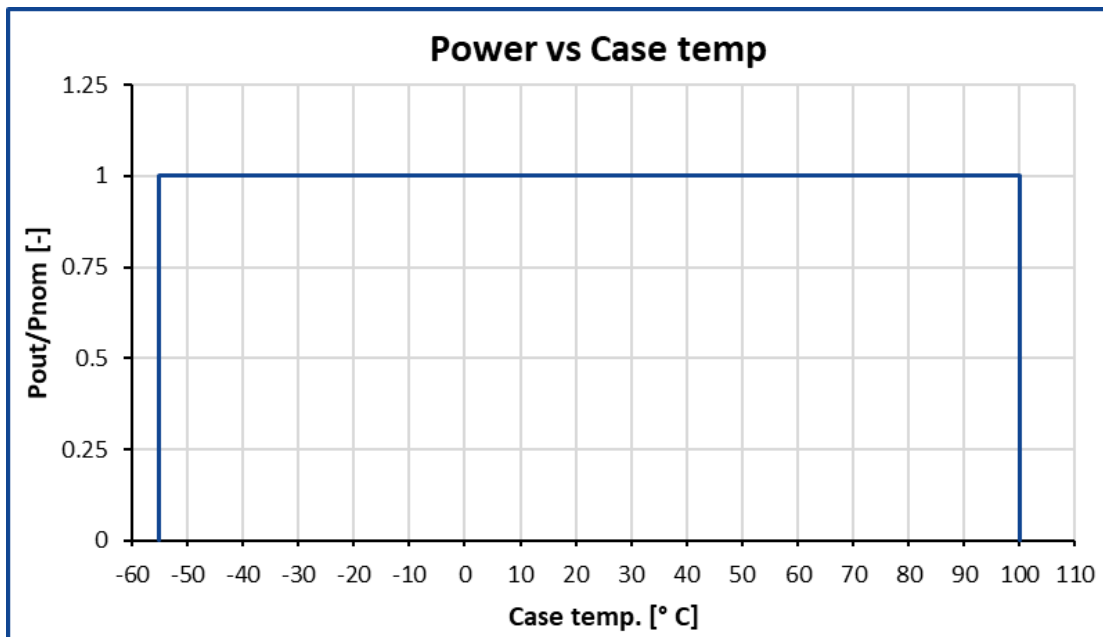
## Minimal necessary connection scheme



In any system application it's necessary to at least use minimal connection scheme consisting of components shown on the picture.

Ck – ceramic capacitors of a certain operating voltage and of several  $\mu\text{F}$  capacity; Ce – electrolytic capacitors of a certain operating voltage and of polymer, aluminum or tantalum type of tens to hundreds  $\mu\text{F}$  capacity. For component values – please see point 5.5 in Reference Technical Material for DC/DC units.

## Power-temperature relationship



## Additional application information

### 1. Value of case temperature

The case temperature is measured at the middle of the long side of the case base. When using a thermocouple, it is necessary to fixate the conductors (connected to the thermocouple end) to the base surface at a distance of at least 20 mm. The thermocouple measuring end and its conductors must be covered with a layer of heat-conducting paste 2-3 mm thick to provide correct measurements.

### 2. Possible cooling methods

- 1) Conductive cooling with aluminum (or copper) **heatsink-coldplate**, for example, aluminum plate thicker than 4 mm.
- 2) Forced air.
- 3) Convectional heatsink cooling with vertical orientation of itself and vertical orientation of its ribs for free air flow from bottom to top.

**To use the units without a heatsink it's mandatory to consult with the producer.**

Most of the unit's dissipated heat (93-95 %) is concentrated on the bottom surface of the unit, its base, which must be attached to the heatsink-coldplate or ribbed heatsink surface. Requirements for the heatsink surface (preferably CNC milled) - flatness tolerance of the heatsink surface must be lower than 0.1 mm per 100 mm of length.

### 3. Unit heatsink fixation

If 4 mounting holes are available, then first one pair of diagonally located holes is connected with screws, then a second pair. First installation of the screws should be done without force. Then all the screws should be tightened with the recommended torque.

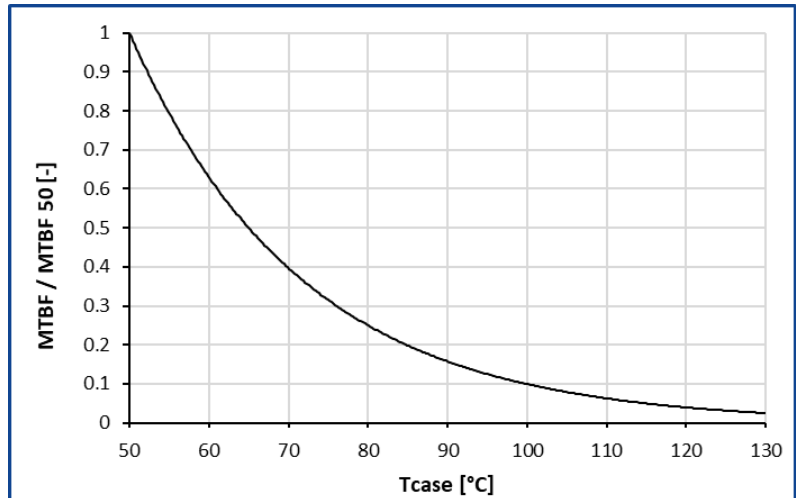
For quality contact between the unit and a heatsink - it's necessary to use thermal conductive paste with thickness less than 0.1 mm, with thermal conductivity **greater than 5 W/K.m**. The paste must be applied with mesh stencil in a pattern of squares (i.e. 2x2 mm to 4x4 mm squares mm with 0.5-1 mm spacing between the squares). This allows paste to be evenly spread in a thin layer and excess air to escape when tightening screws during unit mounting.

### 4. Short-term unit operation

If it's necessary to shortly turn on the unit for 3-5 minutes (for example for input-control testing), an aluminium (copper) coldplate must be used as a heatsink. Its width and length must be not less than of the unit itself, with thickness at least 10 mm. The unit must be placed on coldplate through a thin (0.15-0.3 mm) silicone-based heat-conducting sheet.

## 5. MTBF dependance on case temperature

When using the unit, a customer must in one way or another monitor maximal heatsink temperature. Maximal heatsink temperature near the center point of the longer unit's side (considered as unit case temperature) must correspond to the expected unit's MTBF. Approximate MTBF function shown on the graph lower, where  $MTBF / MTBF_{50}$  is unit's MTBF value at chosen unit's case operating temperature relative to value at 50°C unit's case temperature. Maximal unit's case temperature is recorded by internal unit's thermal sensor-monitor.



## 6. Thermal protection tripping

When internal unit's thermal protection is tripped (typ. +125 °C) the unit is turned off (until automatic restart). **Such state should lead to measures of forced heatsink cooling, for example via fans turn-on.** Time before automatic restart of the unit after thermal protection tripping can last from several seconds up to several minutes depending on thermal inertia of the heatsink.

## 7. Operation with shorted outputs

The units have a short-circuit output protection. **The protection is for emergency only, not for long-term operation. It's prohibited to use the units with shorted outputs (the units have the special detectors inside).**

## 8. Reliability of in-parallel connected units system

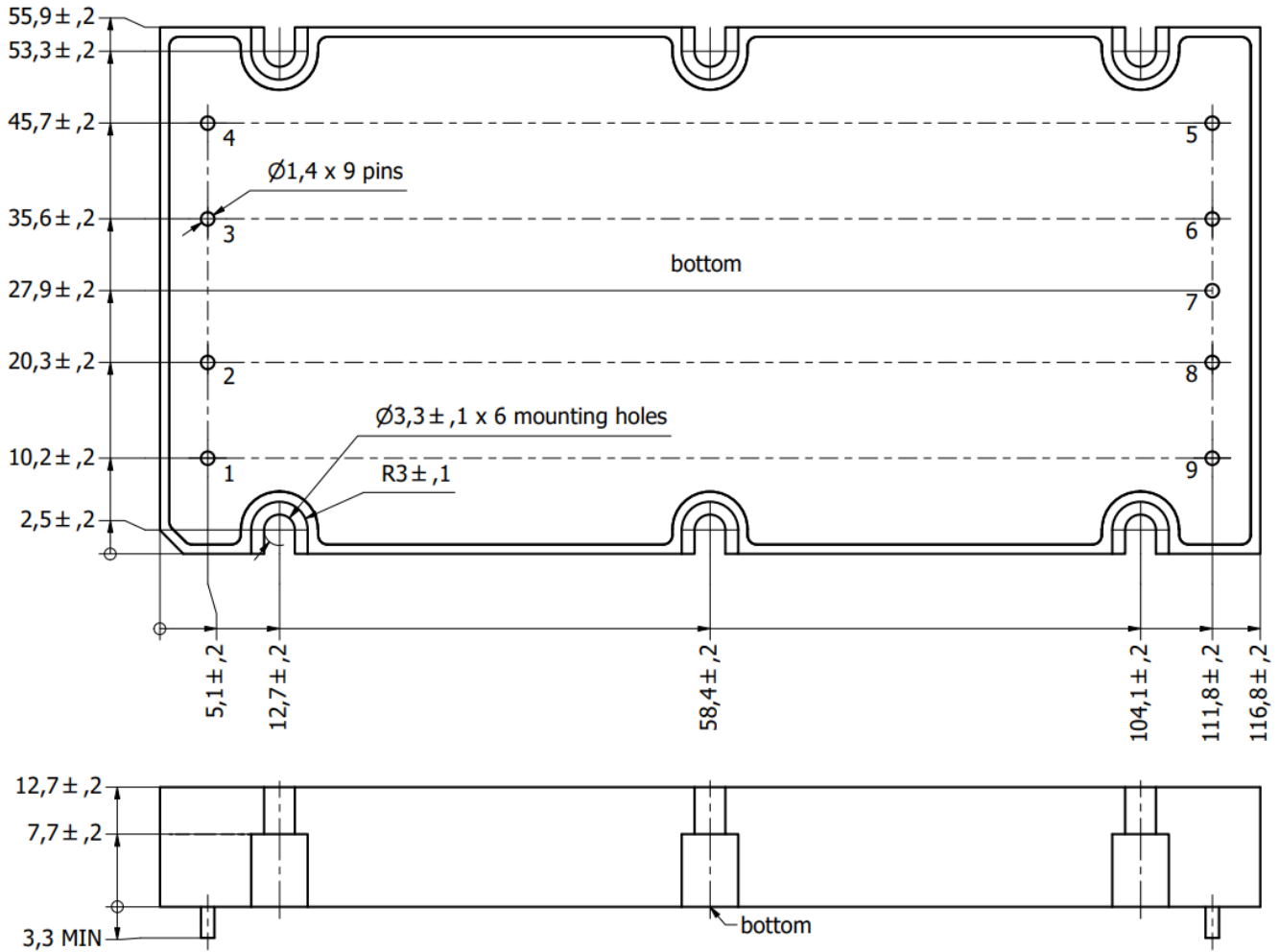
To maximize reliability of in-parallel connected units system (for case of failure of one in-parallel connected units), with minus outputs (-OUT) directly connected together - plus outputs (+OUT) should be connected through separating diodes. Usually, Schottky diodes with breakdown voltage at least twice of unit's output voltage are used for such purpose. PAR outputs of all in-parallel connected units must be directly connected together.

If you have any questions, please contact us directly at [aeps@aeps-group.cz](mailto:aeps@aeps-group.cz).

## Dimensions - one channel

1	2	3	4	5	6	7	8	9
+IN	Prim Control	Parallel	-IN	-OUT	-Sense	Sec Control	+Sense	+OUT

Dimensions in millimeters, 4 installation holes, PCB mounting only.



## Additional information

After ordering the product - the customer is fully responsible for applying the product in strict compliance with mentioned rules and principles of use in the product datasheet and reference technical material (RTM) which is downloadable at [www.aeps-group.com](http://www.aeps-group.com).

Please, note that all information in this material is for reference only. Further detailed information (including: additional requirements, manuals and circuit schemes, etc.) is found at [www.aeps-group.com](http://www.aeps-group.com) or provided via an email request at [aeps@aeps-group.cz](mailto:aeps@aeps-group.cz). All pictures shown are for illustration purpose only, actual product appearance may vary, incl. inner components choice and placement and connectors placement.

According to company's policy in view of constant improvements of the production design the manufacturer reserves the right to change the contents of specifications and promotional materials without prior notice! Make sure you are using the latest documentation downloadable at [www.aeps-group.com](http://www.aeps-group.com).

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